

# 3A, 150V Trench Schottky Surface Mount Rectifier

#### **FEATURES**

- Low power loss, high efficiency
- Ideal for automated placement
- High surge current capability
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

#### **APPLICATIONS**

- Switching mode power supply (SMPS)
- Adapters
- DC to DC converter

### **MECHANICAL DATA**

- Case: TO-277A (SMPC)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 1A whisker test
- Polarity: Indicated by cathode band
- Weight: 0.095g (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
I <sub>F</sub>	3	А	
V <sub>RRM</sub>	150	V	
I <sub>FSM</sub>	90	А	
T <sub>J MAX</sub>	150	°C	
Package	TO-277A (SMPC)		
Configuration	Single die		





TO-277A (SMPC)

Anode 1 O	K N O Cathada
Anode 2 O	→ Cathode

ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)				
PARAMETER	SYMBOL	TSP3H150S	UNIT	
Marking code on the device		3H150		
Repetitive peak reverse voltage	V <sub>RRM</sub>	150	V	
Reverse voltage, total rms value	V <sub>R(RMS)</sub>	105	V	
Forward current	I <sub>F</sub>	3	А	
Surge peak forward current, 8.3ms single half sine wave superimposed on rated load	I <sub>FSM</sub>	90	А	
Non-repetitive peak reverse current <sup>(1)</sup>	I <sub>RSM</sub>	2	А	
Critical rate of rise of off-state voltage	dv/dt	10,000	V/µs	
Junction temperature	TJ	-55 to +175	°C	
Storage temperature	T <sub>STG</sub>	-55 to +175	°C	

#### Notes:

1. Pulse width: 5µs / pulse No.: 10 times



THERMAL PERFORMANCE			
PARAMETER	SYMBOL	ТҮР	UNIT
Junction-to-lead thermal resistance	R <sub>ejl</sub>	16.0	°C/W
Junction-to-ambient thermal resistance	R <sub>eja</sub>	58.5	°C/W
Junction-to-case thermal resistance	R <sub>eJC</sub>	21.5	°C/W

Thermal Performance Note: Units mounted on recommended PCB (16mm x 16mm Cu test board)

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
Forward voltage <sup>(1)</sup>	$I_F = 1A, T_J = 25^{\circ}C$	V <sub>F</sub>	0.65	0.74	V
	$I_F = 3A, T_J = 25^{\circ}C$		0.77	0.86	V
	$I_F = 1A, T_J = 125^{\circ}C$		0.53	0.62	V
	$I_F = 3A, T_J = 125^{\circ}C$		0.62	0.71	V
Poweree everent $@$ reted $V^{(2)}$	$T_J = 25^{\circ}C$	I <sub>R</sub> -	-	10	μA
Reverse current @ rated $V_R^{(2)}$	T <sub>J</sub> = 125°C		-	10	mA
Junction capacitance	1MHz, V <sub>R</sub> = 4.0V	CJ	150	-	pF
Reverse recovery time	IF = 0.5A, IR = 1.0A Irr = 0.25A	t <sub>rr</sub>	20	-	ns

#### Notes:

1. Pulse test with PW = 0.3ms

2. Pulse test with PW = 30ms

ORDERING INFORMATION				
ORDERING CODE	PACKAGE	PACKING		
TSP3H150S	TO-277A (SMPC)	6,000 / Tape & Reel		



## **CHARACTERISTICS CURVES**

(T<sub>A</sub> = 25°C unless otherwise noted)

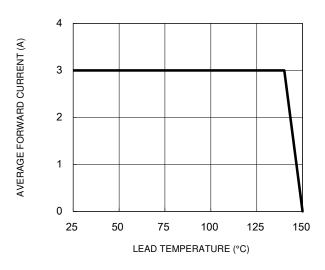
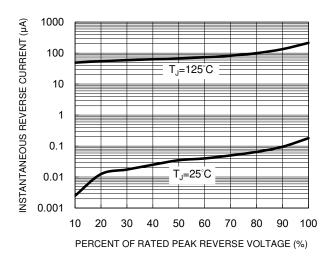


Fig.1 Forward Current Derating Curve

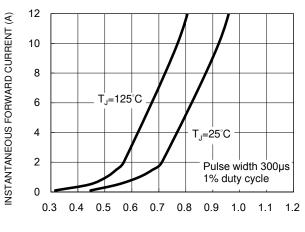
#### **Fig.3 Typical Reverse Characteristics**



 $\begin{array}{c} 100 \\ (1)$ 

#### Fig.2 Typical Junction Capacitance

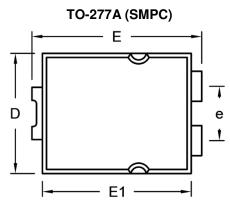
**Fig.4 Typical Forward Characteristics** 

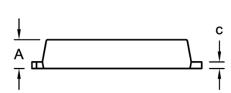


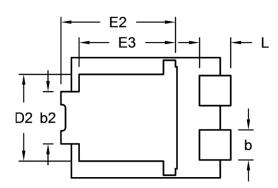
FORWARD VOLTAGE (V)



# PACKAGE OUTLINE DIMENSIONS

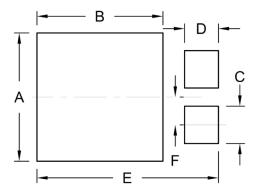




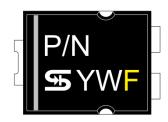


#### Unit (mm) Unit (inch) DIM. Min. Min. Max. Max. 1.000 1.200 0.039 0.047 А b 1.000 1.300 0.039 0.051 b2 1.850 2.150 0.073 0.085 0.175 0.325 0.007 0.013 С D 4.550 4.650 0.179 0.183 3.170 3.470 D2 0.125 0.137 Е 6.350 6.650 0.250 0.262 E1 5.650 5.750 0.222 0.226 E2 4.235 4.535 0.167 0.179 E3 3.540 3.840 0.139 0.151 е 1.930 2.230 0.076 0.088 L 1.043 1.343 0.041 0.053

# SUGGESTED PAD LAYOUT



### **MARKING DIAGRAM**



Symbol	Unit (mm)	Unit (inch)
А	4.80	0.189
В	4.72	0.186
С	1.40	0.055
D	1.27	0.050
E	6.80	0.268
F	1.04	0.041

P/N = Marking Code

YW = Date Code

F = Factory Code



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